

650V Super-junction Power MOSFET

Description

650V Super-junction Power MOSFET

Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The Multi-EPI SJ MOSFET provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

Features

- Very low FOM RDS(on)×Qg
- 100% avalanche tested
- Easy to use/drive
- RoHS compliant

Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

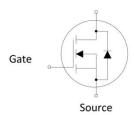
Drain

Charger

TO-3PN









Device Marking and Package Information

Device	Package	Marking	
TPV65R040M	TO-3PN	65R040M	
TPW65R040M	TO-247	65R040M	

Key Performance Parameters

Parameter	Value	Unit
V _{DS} @ T _{j,max}	700	V
R _{DS(on),max}	0.04	Ω
$Q_{g,typ}$	160	nC
I _D	72	A
I _{D,pulse}	216	A
E _{OSS} @ 400V	19.71	μJ
Body Diode di _F /dt	500	A/µs



Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted					
Parameter		Symbol	Value	Unit	
Continuous Drain Current	T _C = 25°C		l _D	72	A
Continuous Drain Current	T _C = 100°C			43.2	
Pulsed Drain Current		(note1)	I _{D,pulse}	216	А
Gate-Source Voltage			V_{GSS}	±30	V
Single Pulse Avalanche Energy	,	(note2)	E _{AS}	2185	mJ
Repetitive Avalanche Energy (note2)		E _{AR}	3.31	mJ	
Avalanche Current		I _{AR}	13.7	А	
MOSFET dv/dt Ruggedness, V _{DS} = 0480V		dv/dt	50	V/ns	
Power Dissipation For TO-3PN,TO-247		P_{D}	500	W	
Continuous Diode Forward Current		I _S	61		
Diode Pulsed Current (note1)		$I_{S,pulse}$	216	A	
Reverse Diode dv/dt (note3)		dv/dt	15	V/ns	
Maximum Diode Commutation Speed (note3)		di _f /dt	500	A/µs	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+150	°C	

Thermal Resistance For TO-3PN,TO-247				
Parameter Symbol Value Unit				
Thermal Resistance, Junction-to-Case	R _{thJC}	0.25	°C/W	
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62	C/VV	

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	_		Value					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static Characteristics	Static Characteristics							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$	650			V		
Zero Gate Voltage Drain Current		$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{\circ}C$	-		1	μA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V, T _J = 150°C	-		100			
Gate-Source Leakage Current	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA		
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V		
Drain-Source On-State-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 25A		0.035	0.04	Ω		
Gate Resistance	R_{G}	f = 1.0MHz open drain		0.3		Ω		
Dynamic Characteristics								
Input Capacitance	C _{iss}	\/ - 0\/		7565		pF		
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 100V,$		268				
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		3.3				
Total Gate Charge	Q_g			160				
Gate-Source Charge	Q_{gs}	$V_{DD} = 520V, I_{D} = 50A,$ $V_{GS} = 10V$		38		nC		
Gate-Drain Charge	Q_{gd}	93		60				
Turn-on Delay Time	t _{d(on)}			45				
Turn-on Rise Time	t _r	V _{DD} = 400V, I _D = 50A,		161				
Turn-off Delay Time	$t_{d(off)}$	$R_G = 25\Omega$		287		ns		
Turn-off Fall Time	t _f			87				
Drain-Source Body Diode Characteristics								
Body Diode Forward Voltage	V _{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 72\text{A}, V_{GS} = 0\text{V}$		0.9	1.2	٧		
Reverse Recovery Time	t _{rr}			540		ns		
Reverse Recovery Charge	Q _{rr}	V _R = 400V, I _F = 30A, di _F /dt = 100A/μs		13.5		μC		
Peak Reverse Recovery Current	I _{rrm}	· '		50.4		Α		

Notes

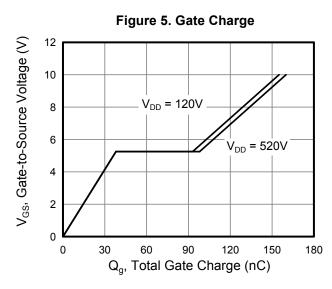
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. I_{AS} = 13.7A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 3. Identical low side and high side switch with identical $R_{\rm G}$

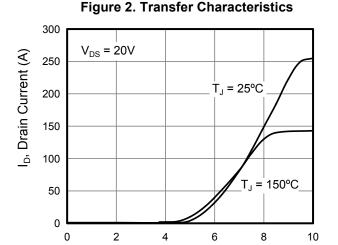
Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

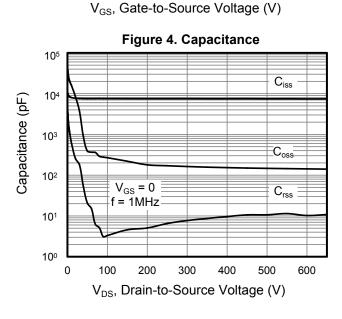
Figure 1. Output Characteristics 300 20V ID, Drain Current (A) 10V 250 8V 200 5.5V 150 5V 100 50 0 10 0 5 15 20

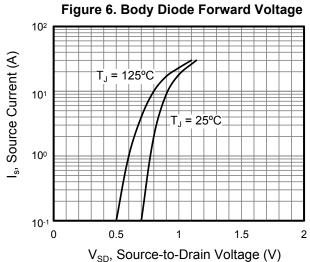
V_{DS}, Drain-to-Source Voltage (V)

Figure 3. On-Resistance vs. Drain Current 0.05 $V_{GS} = 10V$ R_{DS(on)}, On-Resistance (Ω) $T_J = 25^{\circ}C$ 0.04 0.03 0.02 0.01 0 10 20 30 40 50 60 I_D, Drain Current (A)









Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

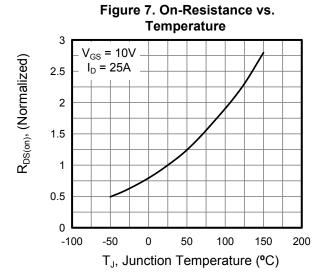


Figure 9. Transient Thermal Impedance For TO-3PN/TO-247

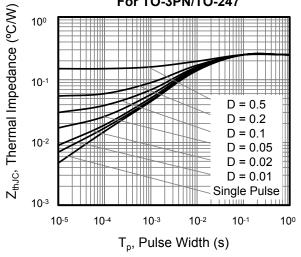


Figure 11. Typ. Coss Stored Energy

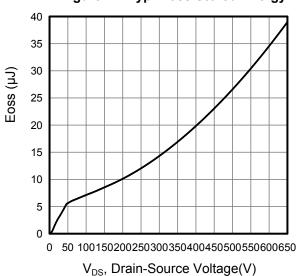


Figure 8. Breakdown voltage vs. Junction Temperature

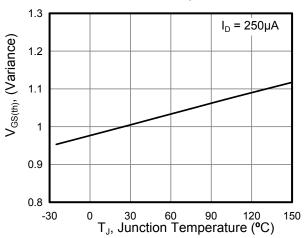


Figure 10. Safe Operation Area For TO-3PN/TO-247

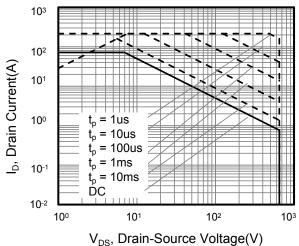




Figure A: Gate Charge Test Circuit and Waveform

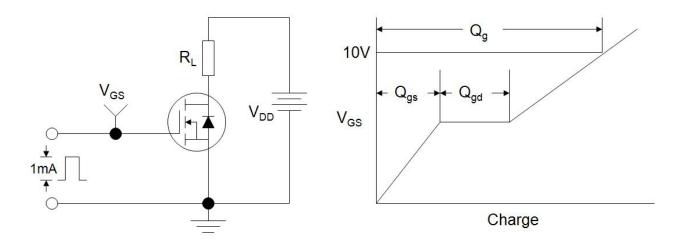


Figure B: Resistive Switching Test Circuit and Waveform

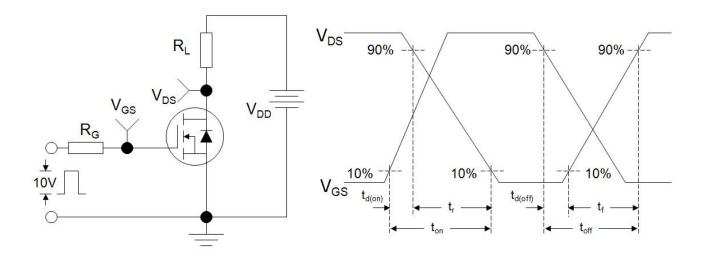
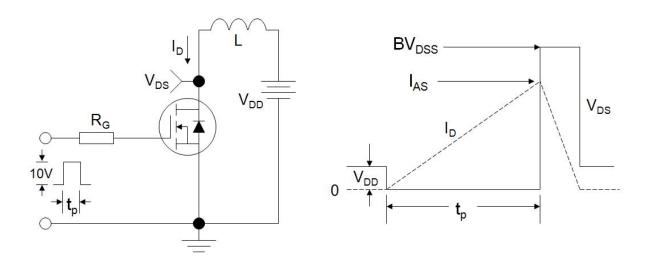


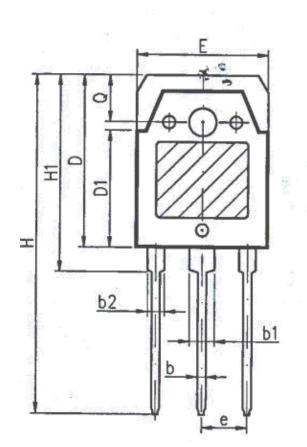
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

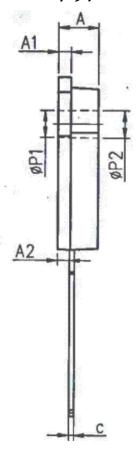


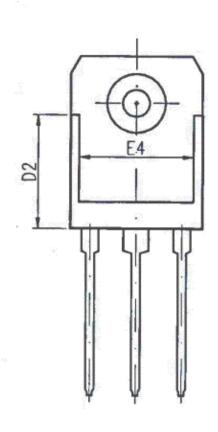
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TO-3PN(华羿)



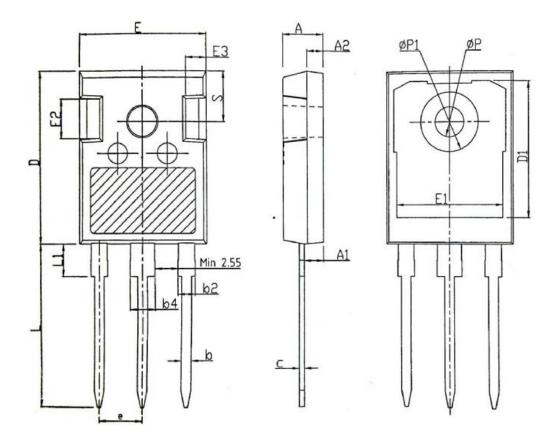




SYMBOL	Tun			
	MIN	NOM	MAX	
A	4.60	4.80	5.00	
A1	1.40	1.50	1.65	
A2	1.18	1.38	1.58	
b	0.80	1.00	1. 20	
_ b1	2.80	3.00	3. 20	
b2	1.80	2.00	2. 20	
c	0.50	0.60	0.75	
D	19, 60	19.90	20. 20	
D1	13. 55	13. 90	14. 25	
D2	12.90 REF			
E	15.35	15.60	15. 85	
E4	12.60	-	-	
e	5. 45 TYP			
H	40.10	40.50	40.90	
H1_	23. 15	23. 40	23.65	
ФР1	3, 20 REF			
ΦP2		3.50	REF	



TO-247(华羿)

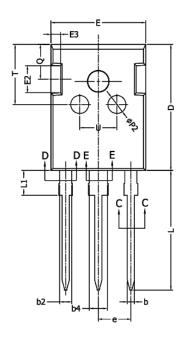


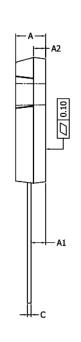
SYMBOL	min CONTROL CO			
	MIN	NOM	MAX	
A	4.80	5.00	5. 20	
A1	2.21	2. 41	2.59	
A2	1.85	2.00	2.15	
b	1.11	1.21	1.36	
b2	1.91	2.01	2.21	
b4	2.91	3.01	3. 21	
С	0.51	0.61	0.75	
D	20.80	21.00	21.30	
D1	16. 25	16.55	16.85	
Е	15.50	15. 80	16. 10	
E1	13.00	13.30	13.60	
E2	4.80	5.00	5. 20	
E3	2.30	2, 50	2.70	
е	5. 44BSC			
L	19.82	19.92	20. 22	
L1	-	-	4. 30	
ФР	3. 40	3.60	3.80	
ФР1	-	-	7.30	
S	6. 15BSC			

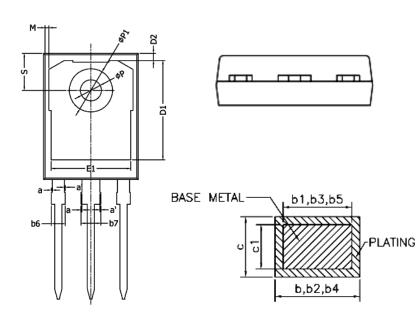
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TO-247 (集佳)







SYMBOL	MIN	NOM	MAX
Α	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
а	0		0.15
a'	0		0.15
b	1.16	 1.2	1.26
b1	1.15	1.2	1.22
b2	1.96		2.06
b3	1.95	2.00	2.02
b4	2.96		3.06
b5	2.96	3.00	3.02
b6			2.25
b7			3.25
С	0.59		0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	2.40	2.50	2.60
е		5.436 BSC	
L	19.80	19.92	20.10
L1			4.30
М	0.35		0.95
Р	3.40	3.50	3.60
P1	7.00		7.40
P2	2.40	2.50	2.60
Q	5.60		6.00
S	6.05	6.15	6.25
Т	9.80		10.20
U	6.00		6.40



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